

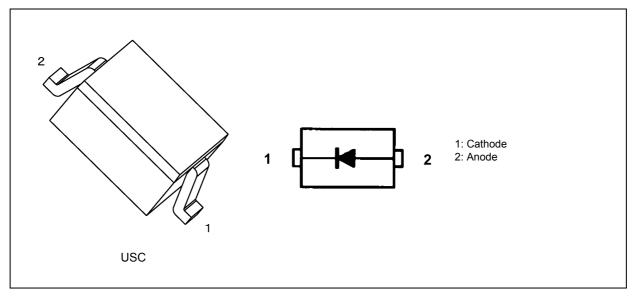
Switching Diodes Silicon Epitaxial Planar

BAS316

1. Applications

• High-Speed Switching

2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		100	V
Reverse voltage	V _R		100	
Peak forward current	I _{FM}		500	mA
Average rectified current	Ι _Ο		250	
Non-repetitive peak forward surge current	I _{FSM}	(Note 1)	1	Α
Power dissipation	PD	(Note 2)	230	mW
Junction temperature	Tj		150	°C
Storage temperature	T _{stg}		-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Measured with a 10 ms pulse.

Note 2: Mounted on an FR4 board (20 mm \times 20 mm, Cu pad: 4 mm \times 4 mm)

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4. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F (1)	I _F = 1 mA	_	—	0.715	V
	V _F (2)	I _F = 10 mA			0.855	
	V _F (3)	I _F = 50 mA	_	_	1.00	
	V _F (4)	I _F = 150 mA	_	—	1.25	
Reverse current	I _R (1)	V _R = 25 V	_	_	30	nA
	I _R (2)	V _R = 80 V	_	_	200	
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	0.35	_	pF
Reverse recovery time	t _{rr}	I _F = 10 mA, See Fig. 4.1.	_	_	3.0	ns

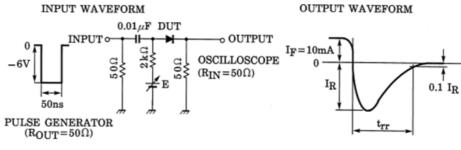
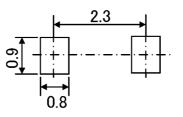


Fig. 4.1 Reverse recovery time (t_{rr}) Test circuit

5. Marking



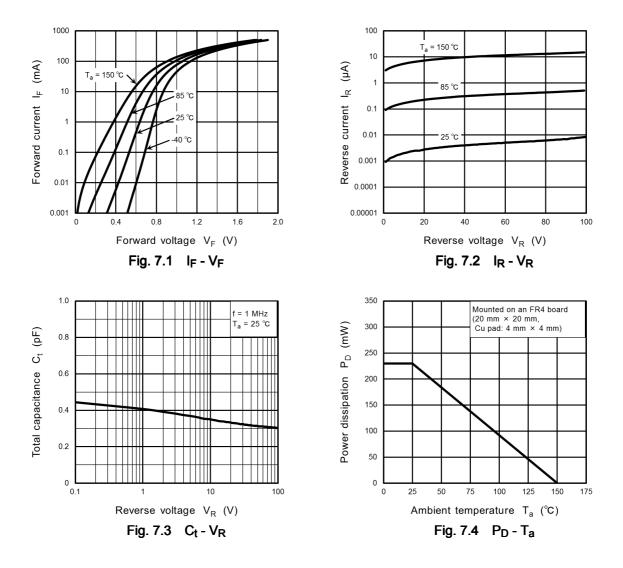
6. Land Pattern Dimensions (for reference only)



Land Pattern Dimensions (Unit: mm)

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7. Characteristics Curves (Note)



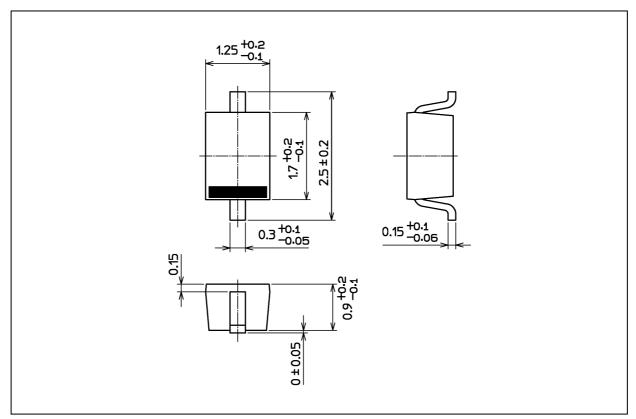
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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Package Dimensions

Unit: mm



Weight: 4.5 mg (typ.)

	Package Name(s)	
JEDEC: SOD-323		
Nickname: USC		

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